DATASHEET

EVERLIGHT AUTOMOTIVE

EL Mini Top View LED

Preliminary

1608-UR0100M-AM

Features

- Package: PLCC 2 package
- Color: Red
- Typical luminous intensity: 350 mcd @ 10mA
- Viewing angle : 120°
- ESD : up to 2KV
- MSL : 3
- Qualifications：According to AEC-Q101
- The product itself will remain within RoHS compliant version
- Compliance with RoHS & REACH
- Compliance Halogen Free. (Br<900ppm,Cl<900ppm,Br+Cl<1500ppm)

Applications

- Automotive Interior Lighting.

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1. Characteristics

Parameter		Symbol	Min.	Typ.	Max.	Unit	Condition
Forward Current		I_F	2	10	20	mA	---
Luminous Intensity[1][2]		IV	280	350	450	mcd	I_F=10mA
Forward Voltage[3]		V_F	1.5	2.10	2.5	V	I_F=10mA
Viewing Angle		φ	---	120	---	deg	I_F=10mA
Dominant Wavelength		λ_d	612	617	621	nm	I_F=10mA
Thermal Resistance (Junction to Solder)	Real	$R_{th\ JS\ real}$	---	150	---	K/W	I_F=10mA
	Electrical	$R_{th\ JS\ el}$	---	120	---		

Notes:

1. Luminous Intensity measurement tolerance: ±8%.
2. The data of Luminous Intensity measured at thermal pad=25°C
3. Forward voltage measurement tolerance: ±0.05V
4. Tolerance of Dominant Wavelength：±1nm.

2. Absolute Maximum Ratings

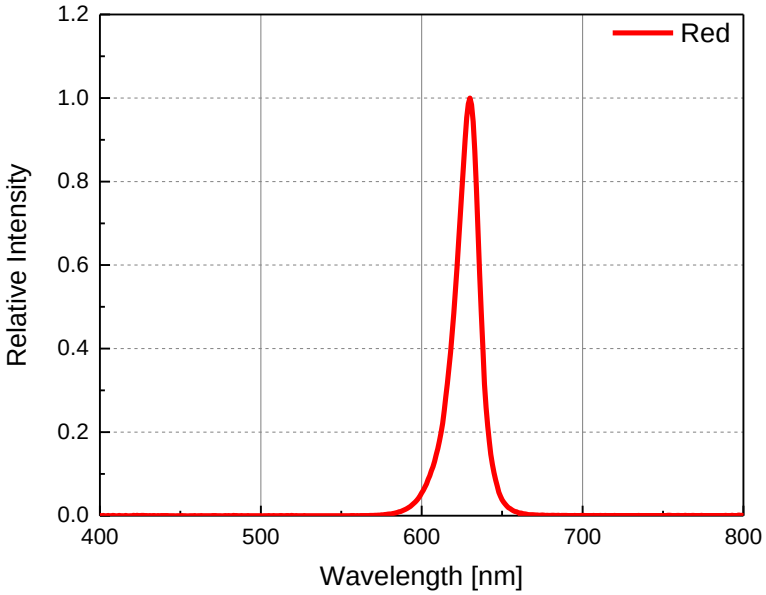
Parameter	Symbol	Ratings	Unit
Power Dissipation	P_d	50	mW
Forward Current	I_F	20	mA
Surge Current (t<=10 μs; D=0.005; T_s=25 ℃)	I_{FM}	50	mA
Reverse Voltage	V_R	Not designed for reverse operation	V
Junction Temperature	T_J	125	°C
Operating Temperature	T_{opr}	-40 ~ +110	°C
Storage Temperature	T_{stg}	-40 ~ +110	°C
ESD Sensitivity (R=1.5kΩ, C= 100pF)	ESD_{HBM}	2	kV
Soldering Temperature	Reflow	260°C for 30sec	°C

3. Characteristics Graph

Wavelength Characteristics Relative Spectral Distribution

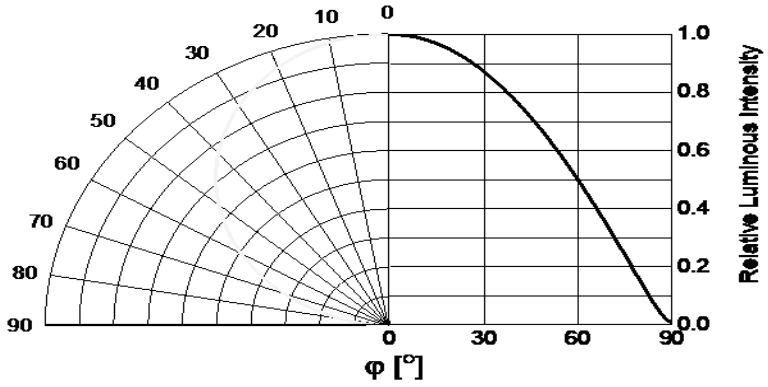
@ Ts = 25°C, I_F=10mA

$\Phi_V / \Phi_V\,(Max.) = f(\lambda)$



Typical Diagram Characteristics of Radiation

$\Phi_V / \Phi_V\,(0^\circ) = f(\varphi)$



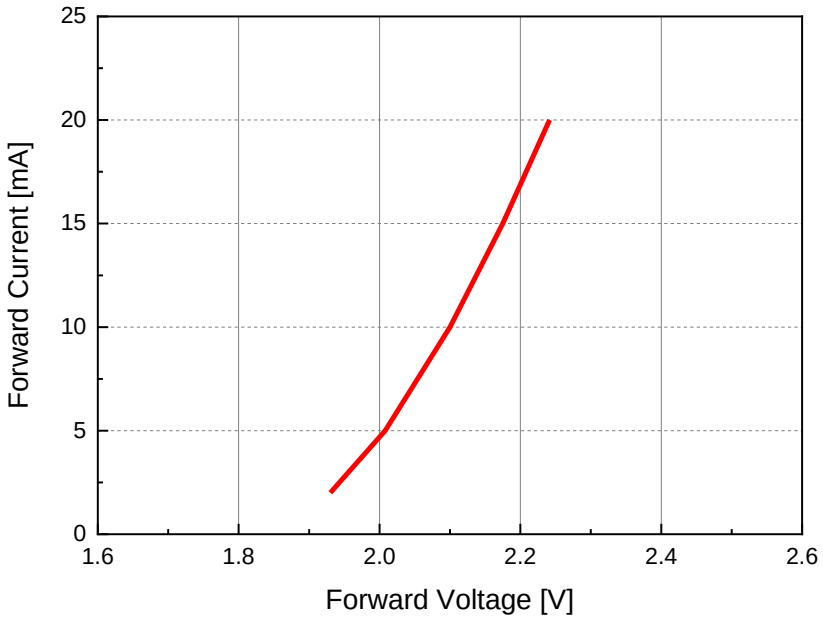
Notes:

1. φ is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
2. View angle tolerance is ± 5°.

Forward Current vs. Forward Voltage

@ Ts = 25°C

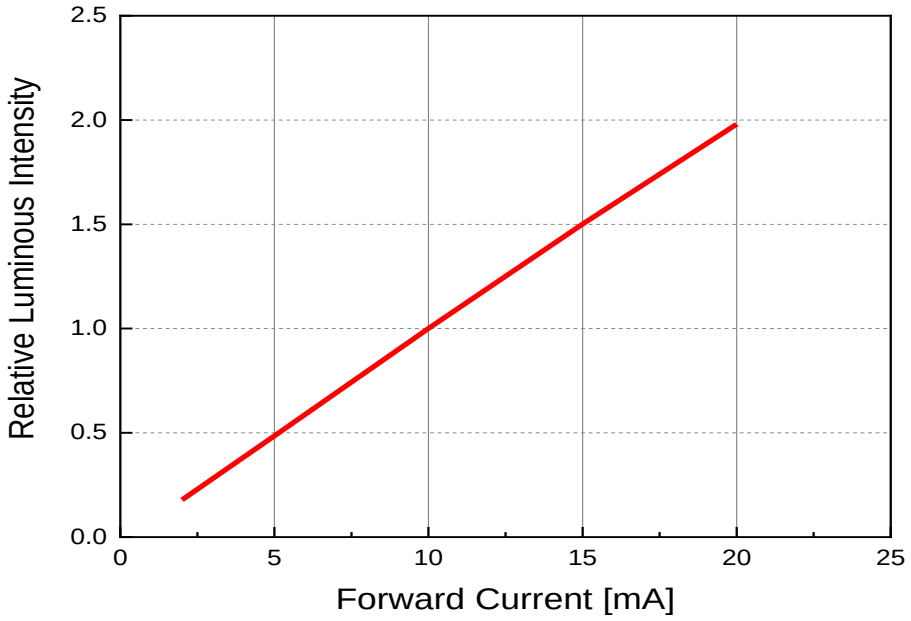
$$I_F = f(V_F)$$



Relative Luminous Intensity vs. Forward Current

@ Ts = 25°C

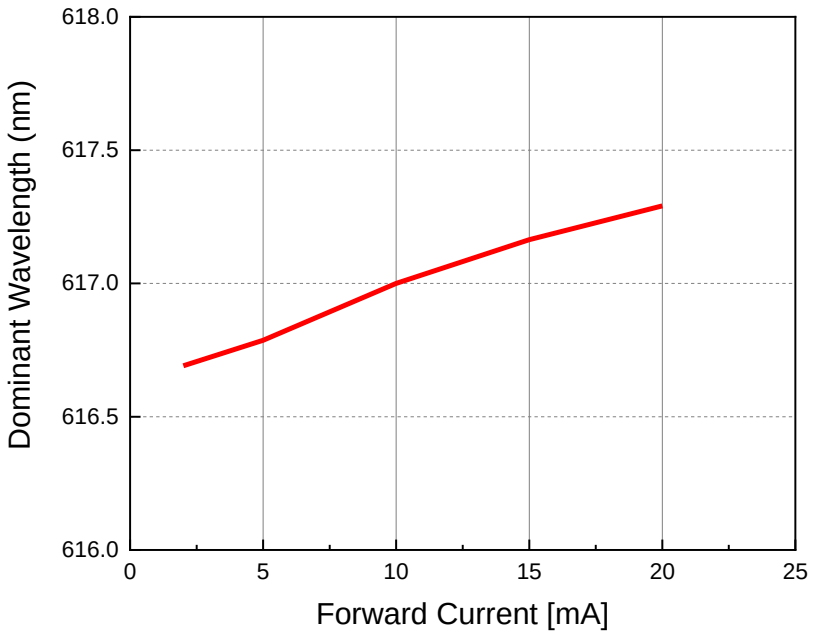
$I_V/I_{V(10mA)} = f(I_F)$



Dominant Wavelength vs. Forward Current

@ Ts = 25°C

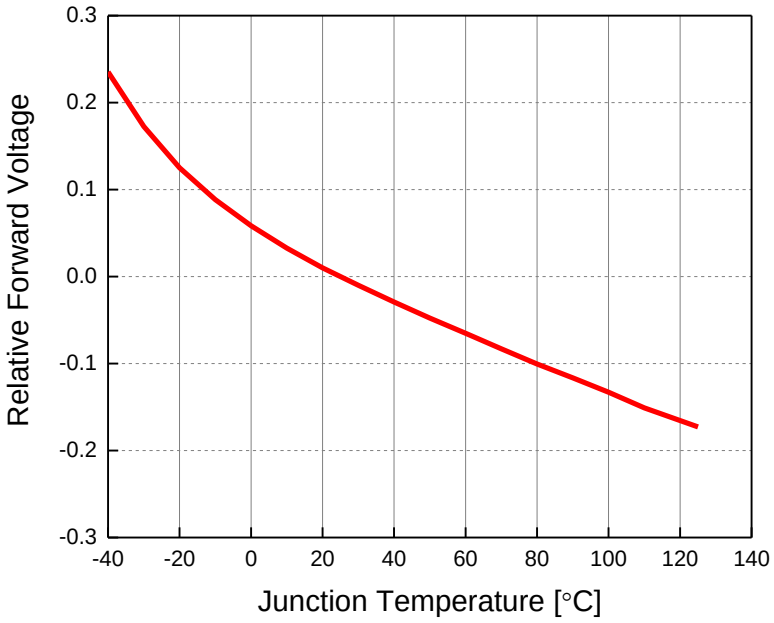
$$\lambda_d = f(I_F)$$



Relative Forward Voltage vs. Junction Temperature

@ I_F=10mA

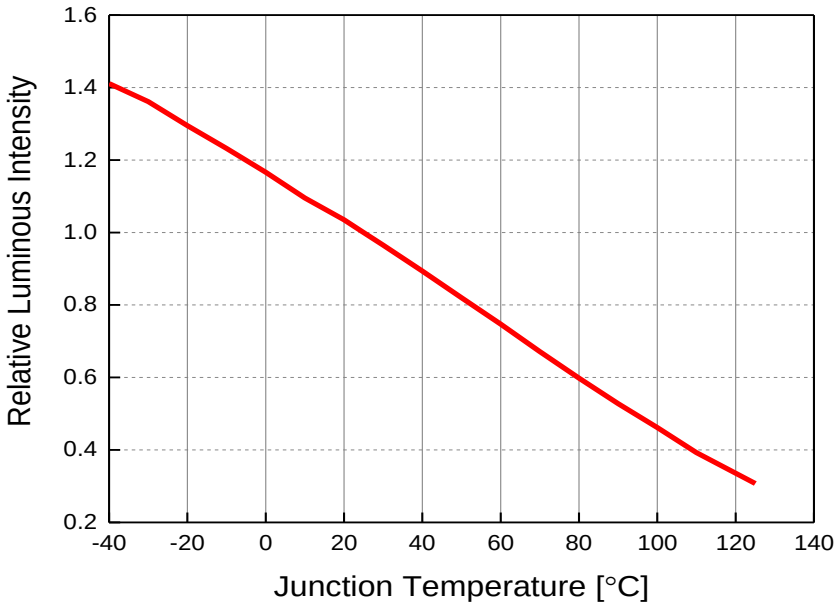
$$\Delta V_F = V_F - V_F(25^\circ C) = f(T_j)$$



Relative Luminous Intensity vs. Junction Temperature

@ I_F=10mA

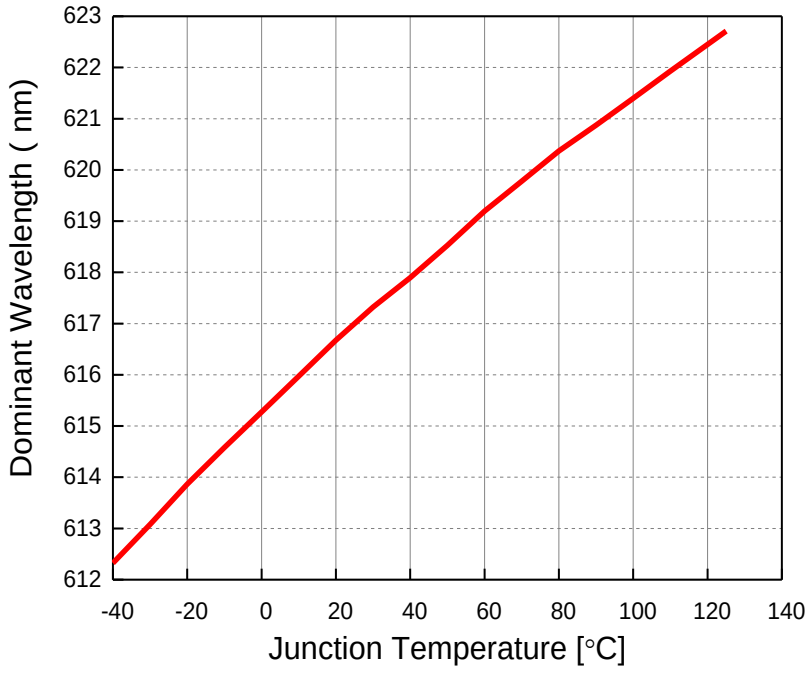
$$\Phi_V / \Phi_V(25^\circ C) = f(T_j)$$



Dominant Wavelength vs. Junction Temperature

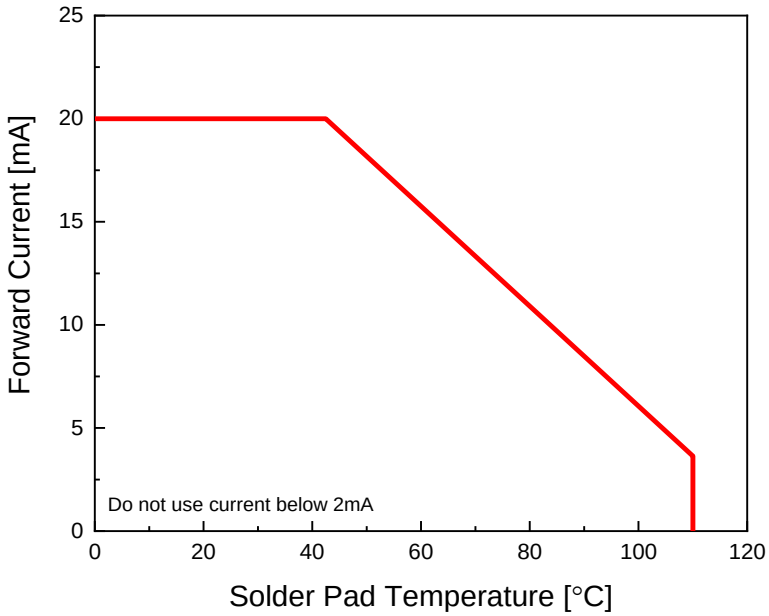
@ I_F=10mA

$$\Delta\lambda_d = \lambda_d - \lambda_d(25^\circ C) = f(T_j)$$



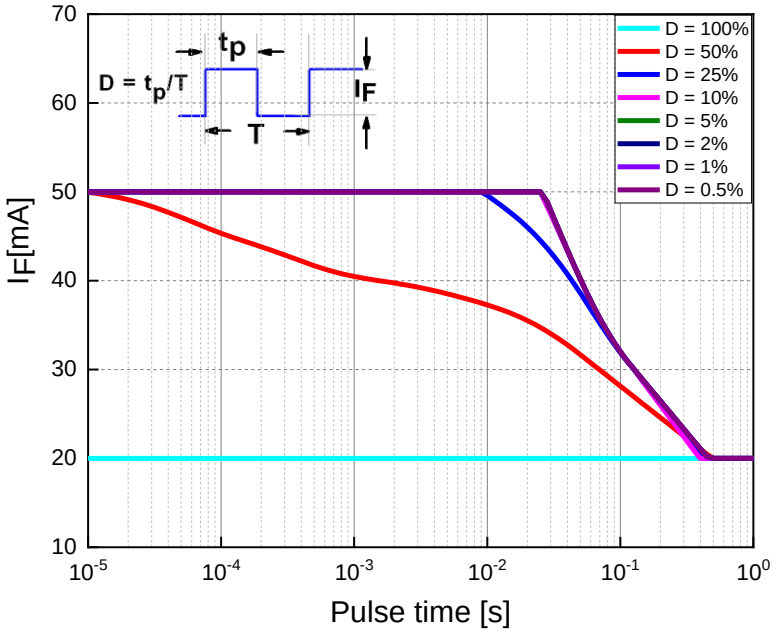
Forward Current Derating Curve

$$I_F = f(T_S)$$



Permissible Pulse Handling Capability

D=Duty cycle , T_S = 25℃



4. Binning Information

Luminous Intensity Bins

Group	Bin	Minimum Luminous Intensity (mcd)	Maximum Luminous Intensity (mcd)
Q	X	71	82
	Y	82	97
	Z	97	112
R	X	112	130
	Y	130	150
	Z	150	180
S	X	180	210
	Y	210	240
	Z	240	280
T	X	280	330
	Y	330	390
	Z	390	450
U	X	450	520
	Y	520	610
	Z	610	710
V	X	710	820
	Y	820	970
	Z	970	1120
A	X	1120	1300
	Y	1300	1500
	Z	1500	1800
B	X	1800	2100
	Y	2100	2400
	Z	2400	2800

Notes:

1. Luminous flux measurement tolerance: ±8%.
2. Highlighted Black Box is possible output bins.

Dominant Wavelength Bins

Group Bin	Minimum Dominant Wavelength [nm]	Maximum Dominant Wavelength [nm]
5963	459	463
6367	463	467
6771	467	471
7175	471	475
1015	510	515
1520	515	520
2025	520	525
2530	525	530
3035	530	535
5861	558	561
6164	561	564
6467	564	567
6770	567	570
7073	570	573
7376	573	576
7679	576	579
7982	579	582
8285	582	585
8588	585	588
8891	588	591
9194	591	594
9497	594	597
9700	597	600
0003	600	603
0306	603	606
0609	606	609
0912	609	612
1215	612	615
1518	615	618
1821	618	621
2124	621	624
2427	624	627
2730	627	630
3033	630	633
3336	633	636
3639	636	639

Notes:

1. Dominant wavelength measurement tolerance: ±1nm.

2. Highlighted Black Box is possible output bins.

Forward Voltage Bins

Bin	Minimum Forward Voltage [V]	Maximum Forward Voltage [V]
1012	1.00	1.25
1215	1.25	1.75
1517	1.50	1.75
1720	1.75	2.00
2022	2.00	2.25
2225	2.25	2.50
2527	2.50	2.75
2730	2.75	3.00
3032	3.00	3.25
3235	3.25	3.50
3537	3.50	3.75
3740	3.75	4.00
4042	4.00	4.25
4245	4.25	4.50
4547	4.50	4.75
4750	4.75	5.00
5052	5.00	5.25
5255	5.25	5.50
5557	5.50	5.75
5760	5.75	6.00
6062	6.00	6.25
6265	6.25	6.50
6567	6.50	6.75
6770	6.75	7.00

Notes:

1. Forward voltage measurement tolerance: ±0.05V.
2. Highlighted Black Box is possible output bins.

5. Part Number

1608-UR0100M-AM

Part number is designated with below details.

1608= Product family name.

UR = Color [1]

010 = Test current [mA]

0 = Internal code

M = Brightness Level

AM = automotive application

Note

[1] Color：

Symbol	Description
C	Cool White
N	Neutral White
W	Warm White
PA	Phosphor Converted Amber
PR	Phosphor Converted Red
UB	Blue
IB	Ice Blue
SB	Sky Blue
UP	Purple
UG	Green
UB	Blue
UY	Yellow
UA	Amber
UR	Red
SR	Super Red
RGB	RGB-Color
RGBY	RGBY-Color

6. Ordering Information

1608-UR0100M-ABCDEFGHJKLM-NO-AM

Part Number of the EL Mini Top View LED	Order Code
1608-UR0100M-AM	1608-UR0100M-ABCDEFGHJKLM-NO-AM

Order code contains information with below details：

ABCD = min/max wavelength or CCT

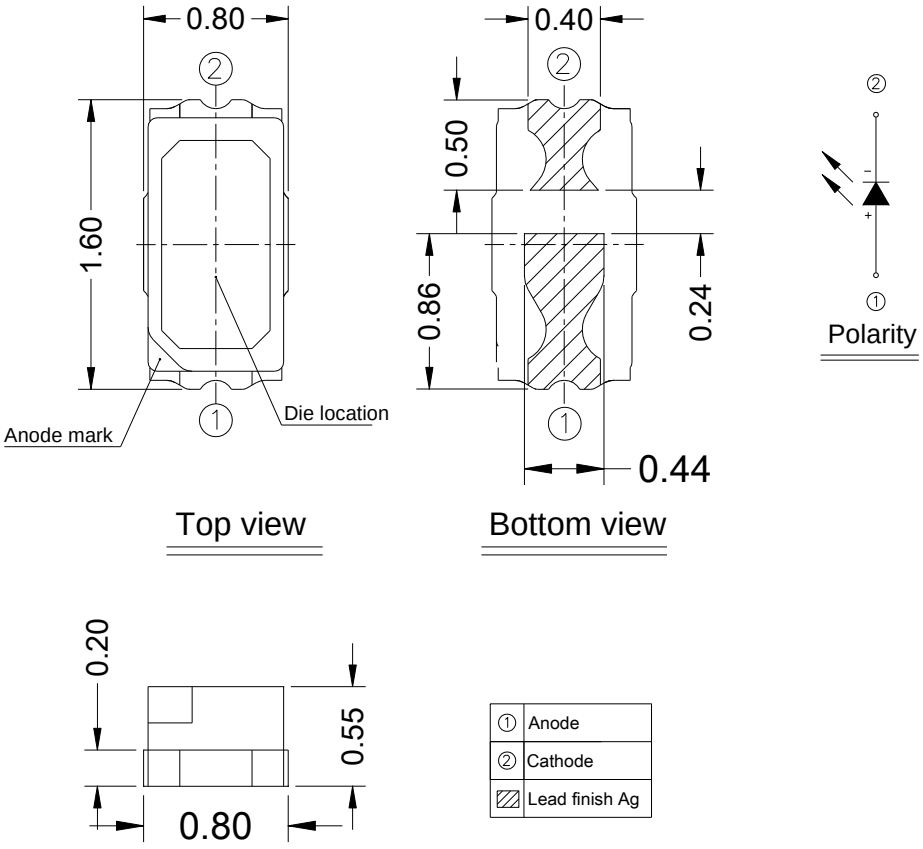
EFGH = min./max. luminous flux in [lm] or luminous intensity in [mcd]

JKLM = min./max. forward voltage

NO =Internal code

AM = Automotive Application

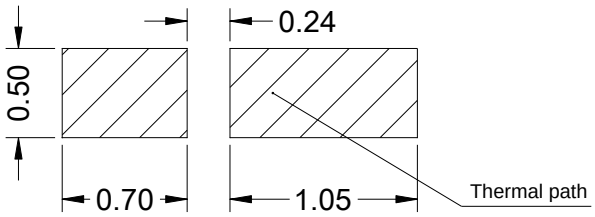
7. Mechanical Dimension



Notes:

1. Dimensions are in millimeters.
2. Tolerances unless mentioned are ± 0.1mm.

8. Recommended Soldering Pad



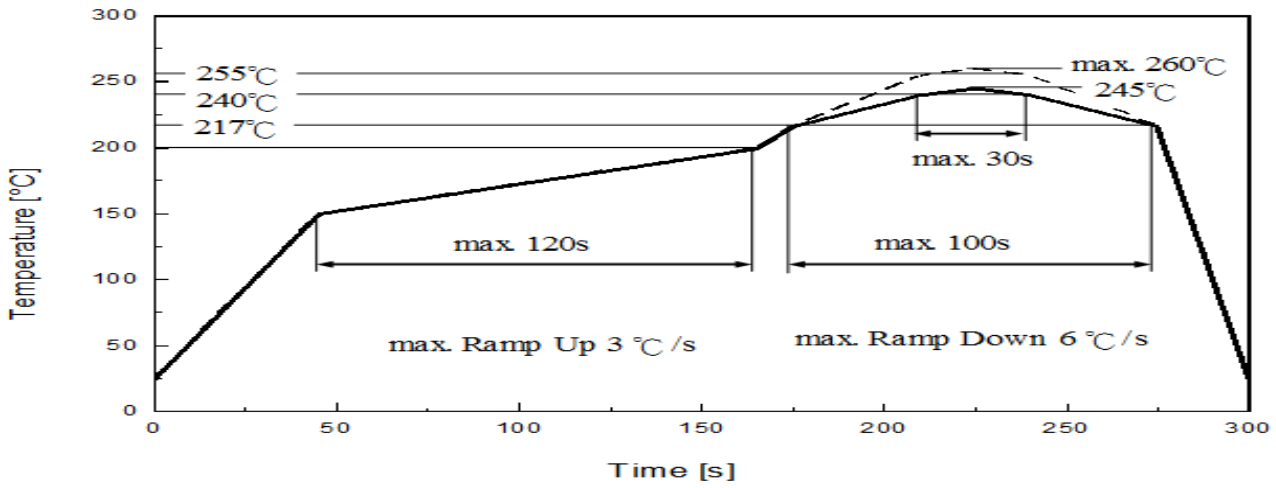
Soldering Pad

Notes:

1. Dimensions are in millimeters.
2. Tolerances unless mentioned are ± 0.1mm.

9. Reflow Soldering Profile

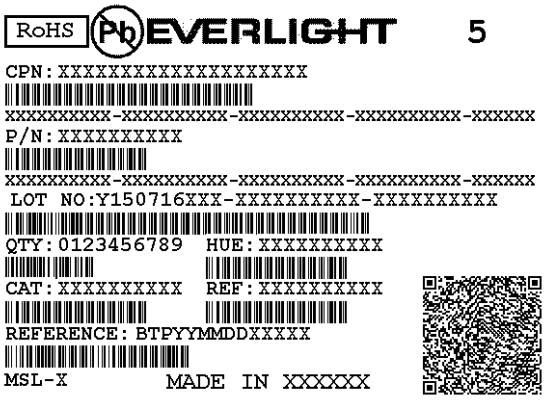
Soldering Condition (Reference: IPC/JEDEC J-STD-020D)



Profile Feature	Pb-Free Assembly Recommendation	Unit Einheit
Ramp-up rate to preheat 25 °C to 150 °C	3	°C /sec
Time of soaking zone 150 °C to 200 °C	120	sec
Ramp-up rate to peak	3	°C /sec
Liquidus temperature	217	°C
Time above liquidus temperature	100	sec
Peak temperature (max.)	260	°C
Time within 5°C of the specified peak temperature	30	sec
Ramp-down Rate (max.)	6	°C /sec

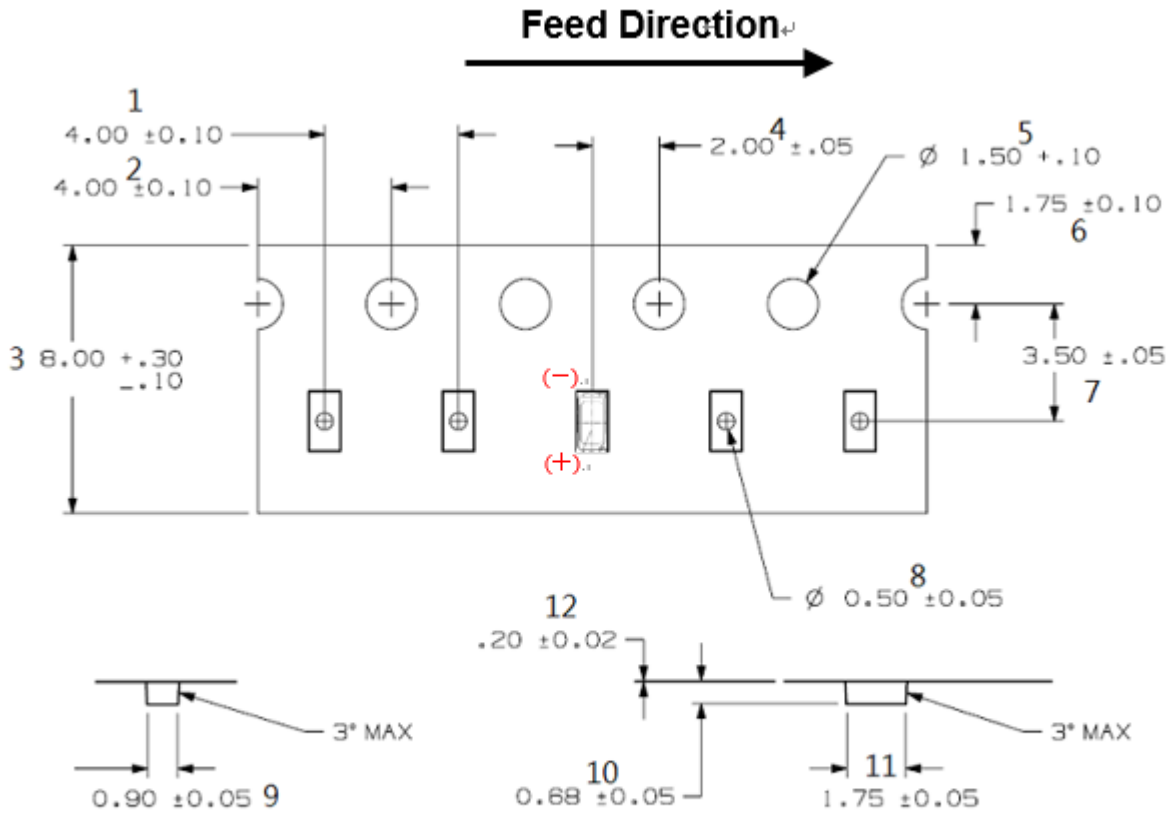
10. Packaging Information

• Product Labeling



- CPN：Customer's Product Number
- P/N： Everlight Part Number
- QTY：Packing Quantity
- CAT：Luminous Flux (Brightness) Bin
- HUE：Color Bin
- REF：Forward Voltage Bin
- LOT No：Lot Number

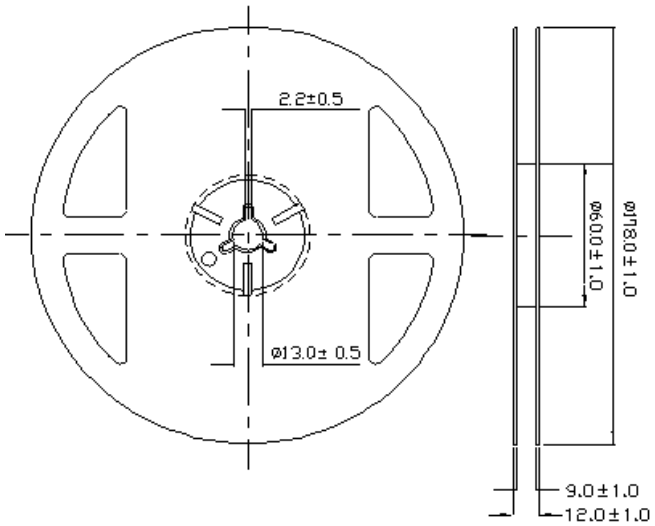
• Packing: Loaded Quantity 2000 pcs Per Reel



Notes:

1. Dimensions are in millimeters.

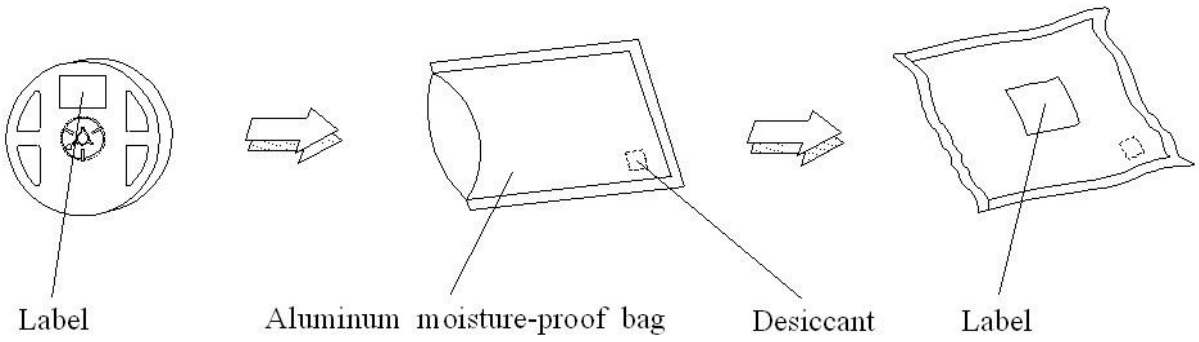
- **Reel Dimensions**



Notes:

Dimensions are in millimeters

- **Moisture Resistant Packing Process**



11. Precaution for Use

1. Over-current-proof
   Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (burn out will happen).

2. Assemblies
   Do not stack assemblies containing LEDs to prevent damage to the optical surface of LEDs. Forces applied to the optical surface may result in the surface being damaged.

3. Soldering Condition
   3.1 When soldering, do not put stress on the LEDs during heating.
   3.2 After soldering, do not warp the circuit board.

4. Soldering Iron
   Each terminal is to go to the tip of soldering iron temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing
   Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

Revision History

Current version: Sep.1.2022

Issue No: Preliminary

Version: 1

Rev.	Subjects (major change in previous version)	Modified date
1	Preliminary data sheet	2022/9/1